



Bill of Materials

TI DESIGNS

TIPD148: Level Translation, Dual to Single Supply Amp, +/-15V to 5V

	Quantity	Value	Description	Manufacturer	Manufacturer PN	DigiKeyPartNumber
1	1	OPA140	36V, RRO, 11MHz, JFET RRO Op Amp	Texas Instruments	OPA140AID	296-28019-5-ND
1	1	OPA188	36V, RRO, Precision Op Amp	Texas Instruments	OPA188AID	296-36185-5-ND
1	1	OPA827	36V, JFET, High Precision Op Amp	Texas Instruments	OPA827AID	296-23816-5-ND
1	1	OPA211	36V, Low Noise/Power Op Amp	Texas Instruments	OPA211AIDR	296-22634-1-ND
1	1	OPA376	5V, Low Noise Precision Op Amp	Texas Instruments	OPA376AID	296-22190-5-ND
1	1	OPA313	5V, Low Noise, 1MHz, Op Amp	Texas Instruments	OPA313IDBVR	296-35607-1-ND
1	1	OPA333	CMOS, Zero-Drift Op Amp	Texas Instruments	OPA333AID	296-19545-5-ND
1	1	OPA350	38MHz, R-R, Op Amp	Texas Instruments	OPA350UA	OPA350UA-ND

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